


**Electronic Filing System (EFS) Data**  
**Electronic Patent Application Submission**  
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EFS ID:	60315	
Application ID:	10709412	
Title of Invention:	[STRUCTURE OF THIN-FILM TRANSISTOR AND METHOD AND EQUIPMENT FOR FABRICATING THE STRUCTURE]	
First Named Inventor:	Wen-Chang Yeh	
Domestic/Foreign Application:	Domestic Application	
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Payment Category:	Credit Card	
Credit Card Number:	*****1007	
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